

MITSUBISHI DIODE MODULES  
**RM30DZ/CZ-M,-H**

MEDIUM POWER GENERAL USE  
INSULATED TYPE

RM30DZ/CZ-M,-H



- **I<sub>F(AV)</sub>** Average forward current ..... **30A**
- **V<sub>RRM</sub>** Repetitive peak reverse voltage ..... **400/800V**
- **DOUBLE ARMS**
- **Insulated Type**
- **UL Recognized**

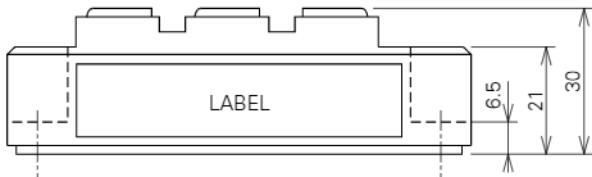
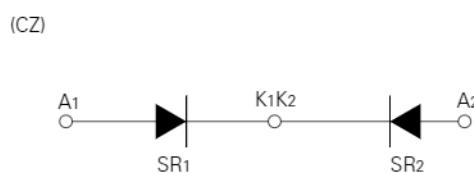
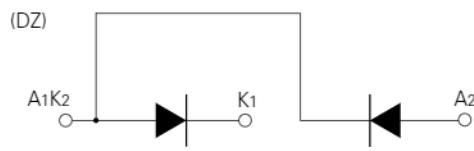
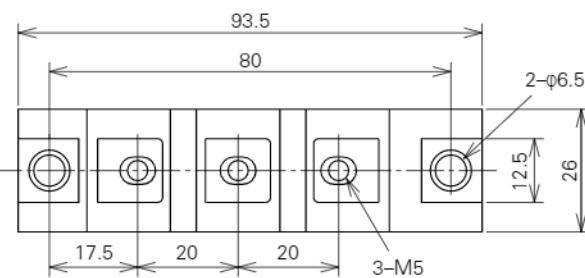
Yellow Card No. E80276 (N)  
File No. E80271

## APPLICATION

AC motor controllers, DC motor controllers, Battery DC power supplies,  
DC power supplies for control panels, and other general DC power equipment

## OUTLINE DRAWING & CIRCUIT DIAGRAM

Dimensions in mm



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## ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Voltage class		Unit
		M	H	
V <sub>RRM</sub>	Repetitive peak reverse voltage	400	800	V
V <sub>RSM</sub>	Non-repetitive peak reverse voltage	480	960	V
V <sub>R (DC)</sub>	Reverse DC voltage	320	640	V

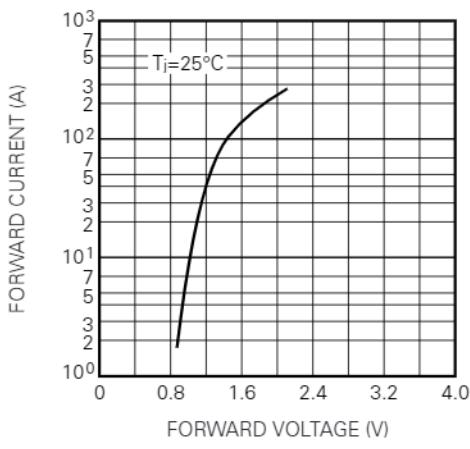
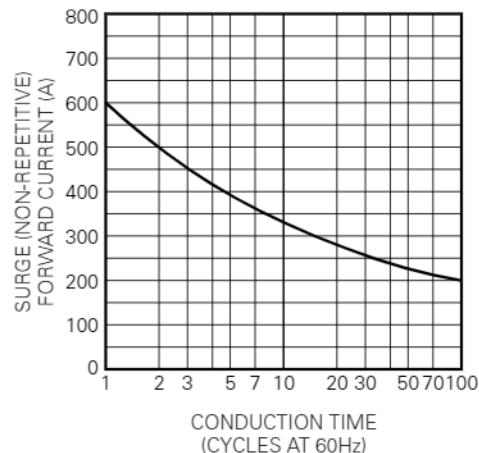
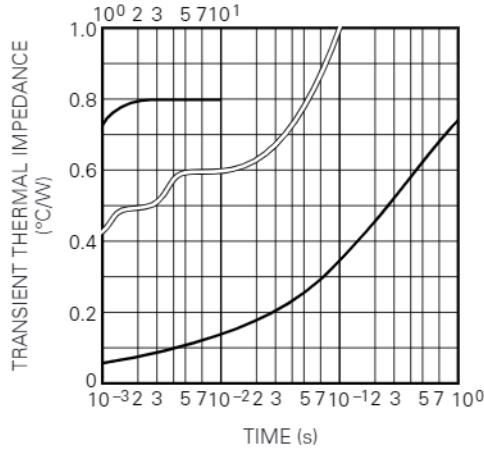
Symbol	Parameter	Conditions	Ratings	Unit
I <sub>F (RMS)</sub>	RMS forward current		47	A
I <sub>F (AV)</sub>	Average forward current	Single-phase, half-wave 180° conduction, T <sub>c</sub> =117°C	30	A
I <sub>FSM</sub>	Surge (non-repetitive) forward current	One half cycle at 60Hz, peak value	600	A
I <sup>2</sup> t	I <sup>2</sup> t for fusing	Value for one cycle of surge current	1.5 · 10 <sup>3</sup>	A <sup>2</sup> s
f	Maximum operating frequency		1000	Hz
T <sub>j</sub>	Junction temperature		-40~+150	°C
T <sub>stg</sub>	Storage temperature		-40~+125	°C
V <sub>iso</sub>	Isolation voltage	Charged part to case	2500	V
—	Mounting torque	Main terminal screw M5	1.47~1.96	N·m
			15~20	kg·cm
		Mounting screw M6	1.96~2.94	N·m
			20~30	kg·cm
—	Weight	Typical value	160	g

## ELECTRICAL CHARACTERISTICS

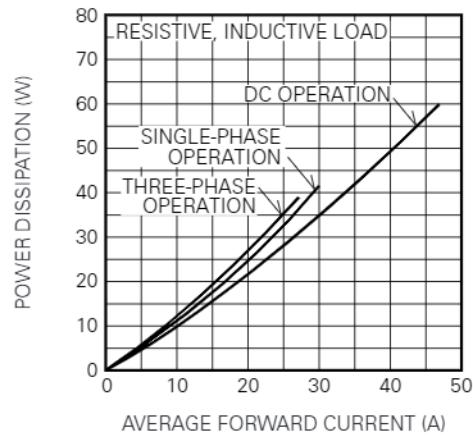
Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
I <sub>RRM</sub>	Repetitive reverse current	T <sub>j</sub> =150°C, V <sub>RRM</sub> applied	—	—	10	mA
V <sub>F</sub>	Forward voltage	T <sub>j</sub> =25°C, I <sub>F</sub> =90A, instantaneous meas.	—	—	1.4	V
R <sub>th (j-c)</sub>	Thermal resistance	Junction to case (per 1/2 module)	—	—	0.8	°C/W
R <sub>th (c-f)</sub>	Contact thermal resistance	Case to fin, conductive grease applied (per 1/2 module)	—	—	0.2	°C/W
—	Insulation resistance	Measured with a 500V megohmmeter between main terminal and case	10	—	—	MΩ

## PERFORMANCE CURVES

MAXIMUM FORWARD CHARACTERISTIC

ALLOWABLE SURGE (NON-REPETITIVE)  
FORWARD CURRENTMAXIMUM TRANSIENT THERMAL IMPEDANCE  
(JUNCTION TO CASE)

MAXIMUM POWER DISSIPATION

ALLOWABLE CASE TEMPERATURE  
VS. AVERAGE FORWARD CURRENT